FAIRCHILD SEMICONDUCTOR®

RURP840CC, RURP860CC

Data Sheet **January 2002**

8A, 400V - 600V Ultrafast Dual Diodes

The RURP840CC and RURP860CC are ultrafast dual diodes with soft recovery characteristics (t_{rr} < 60ns). They have low forward voltage drop and are silicon nitride passivated ion-implanted epitaxial planar construction.

These devices are intended for use as freewheeling/clamping diodes and rectifiers in a variety of switching power supplies and other power switching applications. Their low stored charge and ultrafast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.

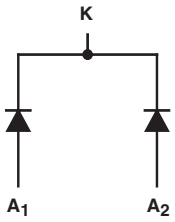
Formerly developmental type TA09616.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RURP840CC	TO-220AB	RURP840C
RURP860CC	TO-220AB	RURP860C

NOTE: When ordering, use the entire part number.

Symbol



Features

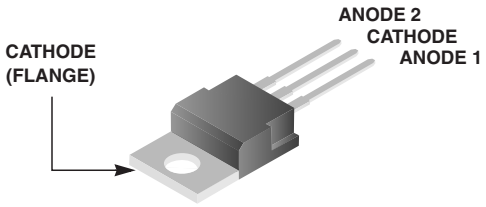
- Ultrafast with Soft Recovery . . . . . <60ns
- Operating Temperature . . . . . 175°C
- Reverse Voltage 600V
- Avalanche Energy Rated
- Planar Construction

Applications

- Switching Power Supplies
- Power Switching Circuits
- General Purpose

Packaging

JEDEC TO-220AB



Absolute Maximum Ratings (Per Leg) T_C = 25°C, Unless Otherwise Specified

		RURP840CC	RURP860CC	UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	400	600	V
Working Peak Reverse Voltage	V_{RWM}	400	600	V
DC Blocking Voltage	V_R	400	600	V
Average Rectified Forward Current (T_C = 155°C)	$I_{F(AV)}$	8	8	A
Repetitive Peak Surge Current (Square Wave, 20kHz)	I_{FRM}	16	16	A
Nonrepetitive Peak Surge Current (Halfwave, 1 phase, 60Hz)	I_{FSM}	100	100	A
Maximum Power Dissipation	P_D	75	75	W
Avalanche Energy (See Figures 10 and 11)	E_{AVL}	20	20	mJ
Operating and Storage Temperature	T_{STG}, T_J	-65 to 175	-65 to 175	°C

Electrical Specifications (Per Leg) $T_C = 25^oC$, Unless Otherwise Specified

SYMBOL	TEST CONDITION	RURP840CC			RURP860CC			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
V_F	I_F = 8A	-	-	1.3	-	-	1.5	V
	I_F = 8A, $T_C = 150^oC$	-	-	1.0	-	-	1.2	V
I_R	V_R = 400V	-	-	100	-	-	-	μA
	V_R = 600V	-	-	-	-	-	100	μA
	V_R = 400V, $T_C = 150^oC$	-	-	500	-	-	-	μA
	V_R = 600V, $T_C = 150^oC$	-	-	-	-	-	500	μA
t_{rr}	I_F = 1A, dI_F/dt = 200A/μs	-	-	60	-	-	60	ns
	I_F = 8A, dI_F/dt = 200A/μs	-	-	70	-	-	70	ns
t_a	I_F = 8A, dI_F/dt = 200A/μs	-	32	-	-	32	-	ns
t_b	I_F = 8A, dI_F/dt = 200A/μs	-	21	-	-	21	-	ns
Q_{RR}	I_F = 8A, dI_F/dt = 200A/μs	-	195	-	-	195	-	nC
C_J	V_R = 10V, I_F = 0A	-	25	-	-	25	-	pF
$R_{\theta JC}$		-	-	2	-	-	2	$^oC/W$

DEFINITIONS

V_F = Instantaneous forward voltage (pw = 300μs, D = 2%).

I_R = Instantaneous reverse current.

t_{rr} = Reverse recovery time (See Figure 9), summation of $t_a + t_b$.

t_a = Time to reach peak reverse current (See Figure 9).

t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 9).

Q_{RR} = Reverse recovery charge.

C_J = Junction Capacitance.

$R_{\theta JC}$ = Thermal resistance junction to case.

pw = pulse width.

D = duty cycle.

Typical Performance Curves

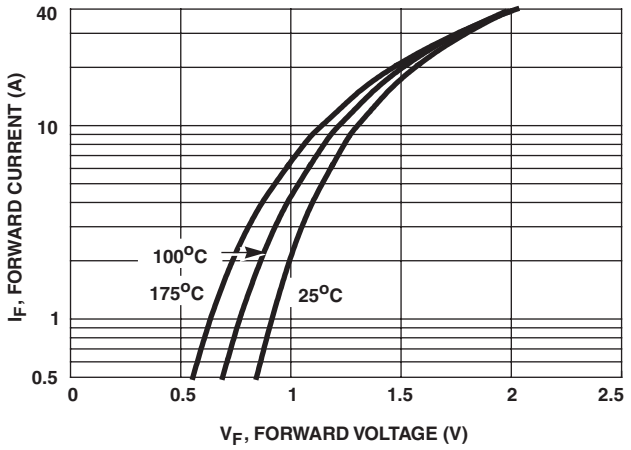


FIGURE 1. FORWARD CURRENT vs FORWARD VOLTAGE

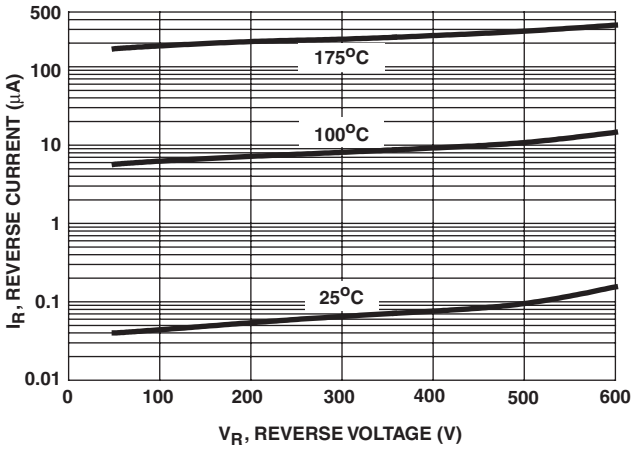


FIGURE 2. REVERSE CURRENT vs REVERSE VOLTAGE

Typical Performance Curves (Continued)

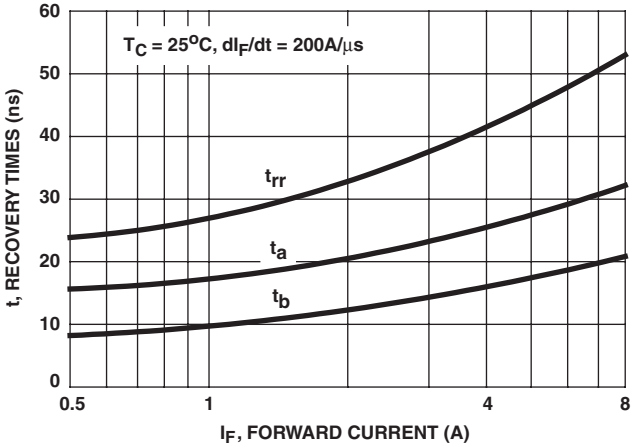


FIGURE 3. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

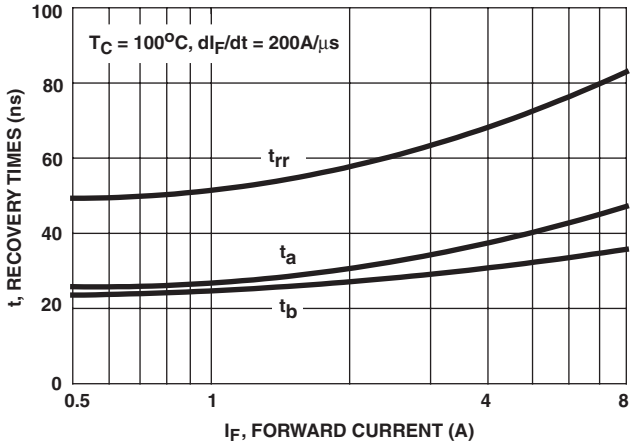


FIGURE 4. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

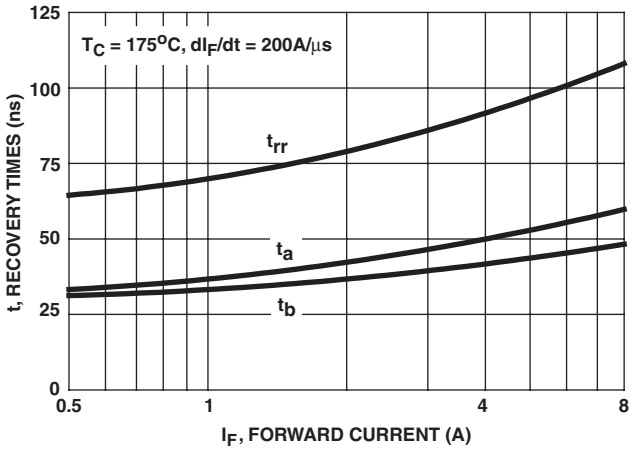


FIGURE 5. t_{rr}, t_a AND t_b CURVES vs FORWARD CURRENT

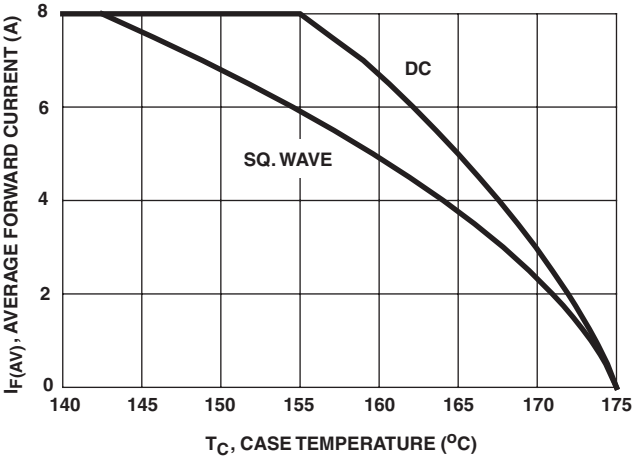


FIGURE 6. CURRENT DERATING CURVE

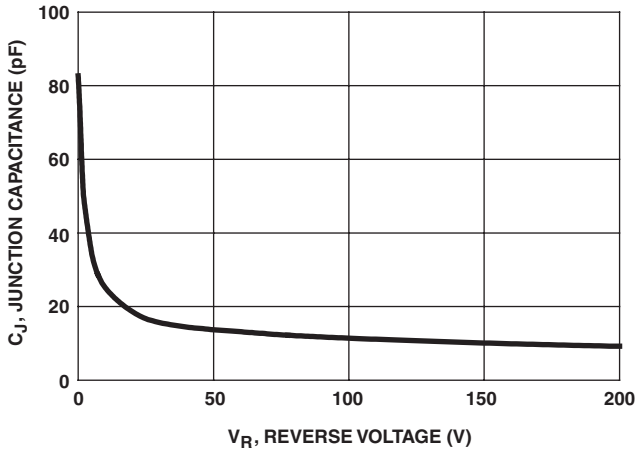


FIGURE 7. JUNCTION CAPACITANCE vs REVERSE VOLTAGE

Test Circuits and Waveforms

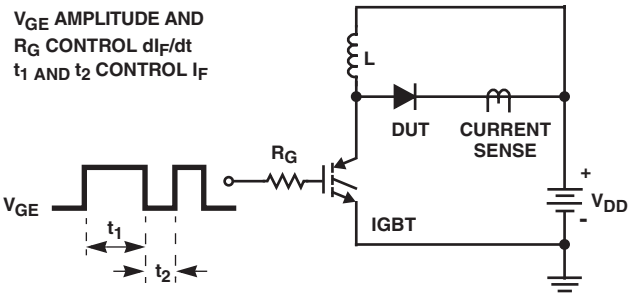


FIGURE 8. t_{rr} TEST CIRCUIT

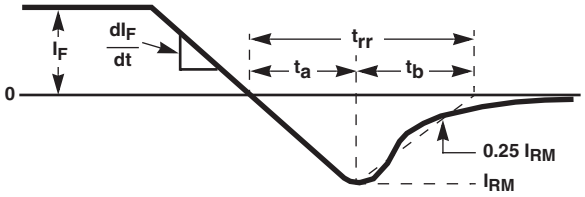


FIGURE 9. t_{rr} WAVEFORMS AND DEFINITIONS

I = 1A
L = 40mH
R < 0.1Ω
$E_{AVL} = 1/2LI^2 [V_{R(AVL)}/(V_{R(AVL)} - V_{DD})]$
Q_1 = IGBT (BV_{CES} > DUT $V_{R(AVL)}$)

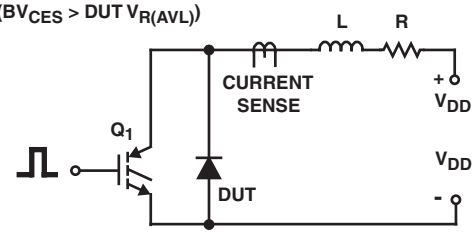


FIGURE 10. AVALANCHE ENERGY TEST CIRCUIT

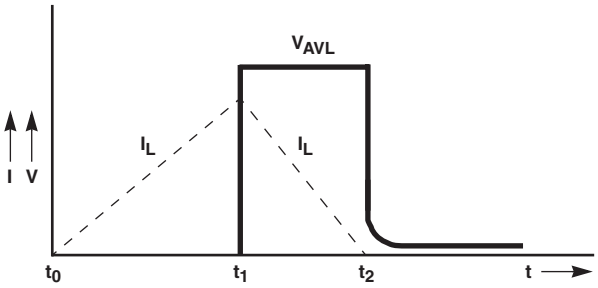


FIGURE 11. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

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